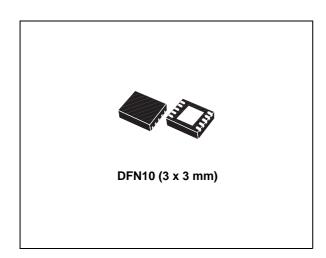


Electronic fuse for 5 V line

Datasheet - preliminary data



Features

- Continuous current typ: 3.6 A
- N-channel on-resistance typ: 40 mΩ
- Enable/fault functions
- Output clamp voltage typ: 6.65 V
- Undervoltage lockout
- Short-circuit limit
- Overload current limit
- · Controlled output voltage ramp
- Thermal latch typ: 165 °C
- · Uses tiny capacitors
- Operating junction temp. 40 °C to 125 °C
- Available in DFN10 (3 x 3 mm).

Applications

- Hard disk drives
- Solid state drives (SSD)

- Hard disk and SSD arrays
- Set-top boxes
- DVD and Blu-ray disc drivers

Description

The STEF05D is an integrated electronic fuse optimized for monitoring output current and input voltage. Connected in series to a 5 V rail, it is capable of protecting the electronic circuitry on its output from overcurrent and overvoltage. The device has a controlled delay and turn-on time. When an overload condition occurs, the STEF05D limits the output current to a predefined safe value. If the anomalous overload condition. persists, it goes into an open state, disconnecting the load from the power supply. If a continuous short-circuit is present on the board, when power is re-applied the E-fuse initially limits the output current to a safe value, and then again goes into an open state.

The device is equipped with a thermal protection circuit. The intervention of the thermal protection is signal led to the board monitoring circuits through a signal on the Fault pin.

Unlike mechanical fuses, which must be physically replaced after a single event, the Efuse does not degrade in its performance after short-circuit/thermal protection interventions and it is reset either by recycling the supply voltage or using the Enable pin.

The companion chip for 12 V power rails is also available with part number STEF12.

Table 1. Device summary

Order code	Package	Packaging
STEF05DPUR	DFN10 (3 x 3 mm)	Tape and reel

Contents STEF05D

Contents

1	Bloc	k diagram					
2	Pin (configuration					
3	Max	imum ratings					
4	Elec	trical characteristics6					
5	Турі	cal application 8					
	5.1	Operating modes					
		5.1.1 Turn-on					
		5.1.2 Normal operating condition					
		5.1.3 Output voltage clamp					
		5.1.4 Current limiting					
		5.1.5 Thermal shutdown					
	5.2	R _{Limit} calculation					
	5.3	C _{dv/dt} calculation					
	5.4	Enable/fault pin					
6	Турі	cal performance characteristics					
7	Pacl	Package mechanical data					
8	Revi	sion history					

STEF05D Block diagram

1 Block diagram

 V_{cc} ENABLE O-CHARGE OSCILLATOR **ENABLE** PUMP POWER SENSE dV/dT **VOLTAGE** CURRENT dV/dT o-CONTROL CONTROL CONTROL THERMAL UVLO GND **PROTECTION** 6 I-LIMIT V_{out} 6 AM09891v1

Figure 1. Device block diagram

Pin configuration STEF05D

2 Pin configuration

Figure 2. Pin configuration (top view)

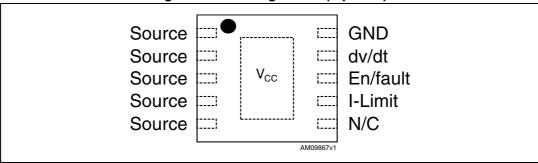


Table 2. Pin description

Pin N°	Symbol	Note
1 to 5	V _{OUT/} Source	Connected to the Source of the internal power MOSFET and to the output terminal of the fuse
6	NC	Not connected
7	I-Limit	A resistor between this pin and the Source pin sets the overload and short-circuit current limit levels.
8	En/Fault	The enable/fault pin is a tri-state, bi-directional interface. During normal operation the pin must be left floating, or it can be used to disable the output of the device by pulling it to Ground using an open drain or open collector device. If a thermal fault occurs, the voltage on this pin will go to an intermediate state to signal a monitor circuit that the device is in thermal shutdown. It can be connected to another device of this family to cause a simultaneous shutdown during thermal events.
9	dv/dt	The internal dv/dt circuit controls the slew rate of the output voltage at turn- on. The internal capacitor allows a ramp-up time of around 1ms. An external capacitor can be added to this pin to increase the ramp time. If an additional capacitor is not required, this pin should be left open.
10	GND	Ground Pin
11	V _{CC}	Exposed pad. Positive input voltage must be connected to V _{CC} .

STEF05D Maximum ratings

3 Maximum ratings

Table 3. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V	Positive power supply voltage (steady state)	-0.3 to 10	V
V _{CC}	Positive power supply voltage (max 100 ms)	-0.3 to 15	V
V _{OUT} /source	(max 100 ms)	-0.3 to Vcc+0.3	V
I-Limit	(max 100 ms)	-0.3 to 15	V
En/Fault		-0.3 to 7	V
dv/dt		-0.3 to 7	V
T _{OP}	Operating junction temperature range ⁽¹⁾	-40 to 125	°C
T _{STG}	Storage temperature range	-65 to 150	°C
T _{LEAD}	Lead temperature (Soldering) 10 sec	260	°C

The thermal limit is set above the maximum thermal rating. It is not recommended to operate the device at temperatures greater than the maximum ratings for extended periods of time.

Note:

Absolute maximum ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

Table 4. Thermal data

Symbol	Parameter	Value	Unit
R _{thJA}	Thermal resistance junction-ambient	52.7	°C/W
R _{thJC}	Thermal resistance junction-case	17.4	°C/W

Table 5. ESD performances

Symbol	Parameter	Test conditions	Value	Unit
		НВМ	2	KV
ESD	ESD Protection	MM	150	V
		CDM	500	V

Electrical characteristics STEF05D

4 Electrical characteristics

 V_{CC} = 5 V, V_{EN} = 3.3 V, C_{I} = 10 $\mu F,\, C_{O}$ = 47 $\mu F,\, T_{J}$ = 25 °C, unless otherwise specified

Table 6. Electrical characteristics for STEF05D

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit		
	Under/Overvoltage Protection							
V _{Clamp}	Output clamping voltage	V _{CC} = 10 V		6.65	7.7	V		
V _{UVLO}	Undervoltage lockout	Turn-on, voltage going up	3.2	3.6	4.3	V		
V _{Hyst}	UVLO Hysteresis			0.40		V		
		Power MOSFET						
t _{dly}	Delay time	Enabling of chip to $I_D = 100 \text{ mA}$ with a 1 A resistive load		200		μs		
_	(1)	T _J = 25 °C		40	60			
R _{DSon}	ON resistance ⁽¹⁾	T _J = 125 °C ⁽²⁾			70	mΩ		
V _{OFF}	Off state output voltage	$V_{CC} = 10 \text{ V}, V_{GS} = 0,$ $R_{Limit} = \text{infinite}$		50	200	mV		
I _D	Continuous current	0.5 inch² pad ⁽²⁾ , T _A = 25 °C		3.6				
		Minimum copper, T _A = 80 °C	1.7			Α		
		Current Limit		I.	I			
I _{Short}	Short-circuit current limit	R _{Limit} = 11 Ω	3.1	4.1	5.1	А		
I _{Lim}	Overload current limit	R _{Limit} = 11 Ω		4		Α		
		dv/dt Circuit						
dv/dt	Output voltage ramp time	Enable to V _{OUT} =4.7V, No C _{dv/dt}		0.8		ms		
		Enable/Fault						
V _{IL}	Low level input voltage ⁽²⁾	Output Disabled	0.35	0.58	0.81	V		
V _{I(INT)}	Intermediate level input voltage ⁽²⁾	Thermal Fault, Output Disabled	0.82	1.4	1.95	V		
V _{IH}	High level input voltage	Output Enabled	1.96	2.64	3.3	V		
V _{I(MAX)}	High state maximum voltage		3.4	4.3	5.4	V		
I _{IL}	Low level input current (sink)	V _{Enable} = 0 V		-10	-30	μΑ		
I _I	High level leakage current for external switch	V _{Enable} = 3.3 V			1	μA		
	Maximum fan-out for fault signal	Total numbers of chips that can be connected to this pin for simultaneous shutdown			3	Units		

Table 6. Electrical characteristics for STEF05D

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
	Total Device					
I _{Bias}	Bias current	Device operational		0.5	2	mA
		Thermal Shutdown		1		IIIA
V _{min}	Minimum operating voltage				3.1	V
	Thermal Latch					
TSD	Shutdown temperature ⁽²⁾			165		°C

^{1.} Pulse test: Pulse width = 300 μ s, Duty cycle = 2%

^{2.} Limits in temperature are guaranteed by design, but not tested in production

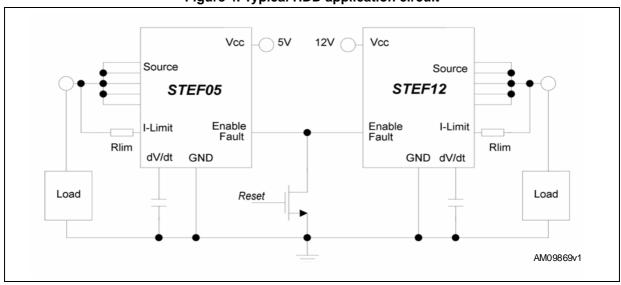
Typical application STEF05D

5 Typical application

C_{IN} EN/Fault Controller GND I-limit GND

Figure 3. Application circuit

Figure 4. Typical HDD application circuit



5.1 Operating modes

5.1.1 Turn-on

When the input voltage is applied, the Enable/Fault pin goes up to the high state, enabling the internal control circuitry.

After an initial delay time of typically 200 µs, the output voltage is supplied with a slope defined by the internal dv/dt circuitry. If no additional capacitor is connected to dv/dt pin, the total time from the Enable signal going high and the output voltage reaching the nominal value is around 1 ms (refer to *Figure 5 and Figure 7*).

AM09868v1

STEF05D Typical application

5.1.2 Normal operating condition

The STEF05D E-fuse behaves like a mechanical fuse, buffering the circuitry on its output with the same voltage shown at its input, with a small voltage fall due to the N-channel MOSFET R_{DSOn}.

5.1.3 Output voltage clamp

This internal protection circuit clamps the output voltage to a maximum safe value, typically 6.65V, if the input voltage exceeds this threshold.

5.1.4 Current limiting

When an overload event occurs, the current limiting circuit reduces the conductivity of the power MOSFET, in order to clamp the output current at the value selected externally by means of the limiting resistor R_{l imit} (*Figure 3*).

5.1.5 Thermal shutdown

If the device temperature exceeds the thermal latch threshold, typically 165°C, the thermal shutdown circuitry turns the power MOSFET off, thus disconnecting the load. The EN/Fault pin of the device will automatically be set at an intermediate voltage, in order to signal the overtemperature event.

From this condition the E-fuse can be reset either by cycling the supply voltage or by pulling down the EN pin below the V_{il} threshold, and then releasing it.

5.2 R_{Limit} calculation

As shown in *Figure 3*, the device uses an internal N-channel sense FET with a fixed ratio, to monitor the output current and limit it at the level set by the user.

The R_{Limit} value for achieving the requested current limitation can be estimated by using the following theoretical formula, together with the graph in *Figure 13*:

Equation 1

RLimit =
$$\frac{42}{Ishort}$$

5.3 C_{dv/dt} calculation

Connecting a capacitor between the $C_{dv/dt}$ pin and GND will allow the modification of the output voltage ramp time.

Given the desired time interval Δt during which the output voltage goes from zero to his maximum value, the capacitance to be added on $C_{dv/dt}$ pin can be calculated using the following theoretical formula:

Typical application STEF05D

Equation 2

$$C_{dvdt} \, = \, 36 \times 10^{-9} \Delta t - 30 x 10^{-12}$$

Where $C_{\text{dv/dt}}$ is expressed in Farad, and the time Δt in seconds.

Figure 5 shows a graphical explanation of delay time and ramp-up time.

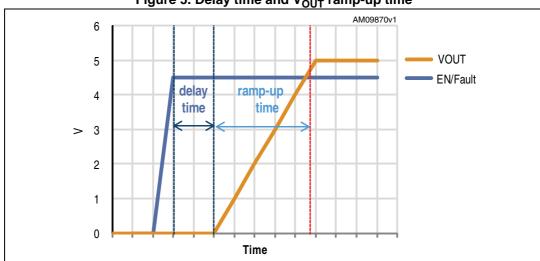


Figure 5. Delay time and V_{OUT} ramp-up time

5.4 Enable/fault pin

The Enable/Fault pin has the dual function of controlling the output of the device and, at the same time, of providing information about the device status to the application.

When it is used, it should be connected to an external open-drain or open-collector device. In this case, when it is pulled at low logic level, it turns the output of the E-Fuse off.

If this pin is left floating, since it has internal pull-up circuitry, the output of the E-Fuse is kept ON in normal operating conditions.

In case of thermal fault, the pin is pulled to an intermediate state (*Figure 6*). This signal can be provided to a monitor circuit, informing it that a thermal shutdown has occurred, or it can be directly connected to the Enable/Fault pins of other STEFxx devices on the same application in order to achieve a simultaneous enable/disable feature.

When a thermal fault occurs, the device can be reset either by cycling the supply voltage or by pulling down the Enable pin below the V_{il} threshold and then releasing it.

STEF05D Typical application

Normal operating condition

Thermal fault condition

Off/Reset

Figure 6. Enable/fault pin status

6 Typical performance characteristics

EN/FLT

The following plots are referred to the typical application circuit and, unless otherwise noted, at $T_A = 25^{\circ}C$.

Figure 7. V_{OUT} ramp-up vs. EN/fault

VCC

VOUT

VOUT

VOUT

VOUT

VOUT

Figure 9. Startup @ short-circuit

Figure 10. Startup @ heavy load

EN/FLT

M 2 0ms 1.25MS/s 800ms/pt A 0h3 / 2.58 V

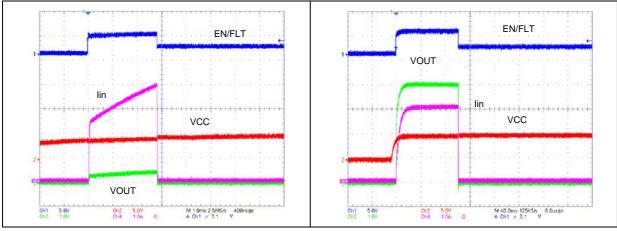


Figure 11. Startup vs. EN/fault

Figure 12. Clamp voltage

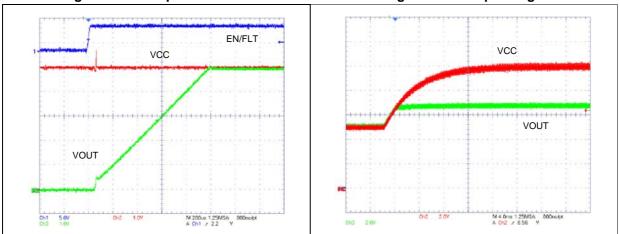


Figure 13. Current limit vs. R_{limit}

Figure 14. R_{DSON} vs. temperature

NAMONETY:

V_{CC} = 5V

V_{CC} = 5V

R_{LIMIT}

Figure 14. R_{DSON} vs. temperature

NAMONETY:

V_{CC} = 5V

Temperature (°C)

7 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Table 7. DFN10L (3 x 3 mm.) mechanical data

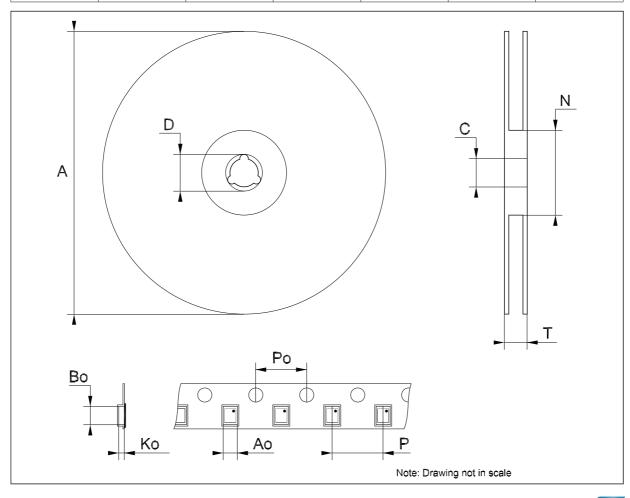
Dim.		mm.	
Dilli.	Min.	Тур.	Max.
А	0.80	0.90	1.00
A1		0.02	0.05
A2	0.55	0.65	0.80
А3		0.20	
b	0.18	0.25	0.30
D	2.85	3.00	3.15
D2	2.20		2.70
E	2.85	3.00	3.15
E2	1.40		1.75
E3		0.230	
E4		0.365	
е		0.50	
L	0.30	0.40	0.50
ddd			0.08

SEATING \circ PLANE ppp D e PIN1 ID (Opt.A). E2 ليا 9 10 8 b PIN1 ID D2 (Opt.B) BOTTOM VIEW 7426335_H

Figure 15. DFN10L package outline

Tape and reel QFNxx/DFNxx (3x3 mm) mechanical data

Dim.		mm.		inch.		
Dilli.	Min.	Тур.	Max.	Min.	Тур.	Max.
Α			330			12.992
С	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
Т			18.4			0.724
Ao		3.3			0.130	
Во		3.3			0.130	
Ko		1.1			0.043	
Ро		4			0.157	
Р		8			0.315	



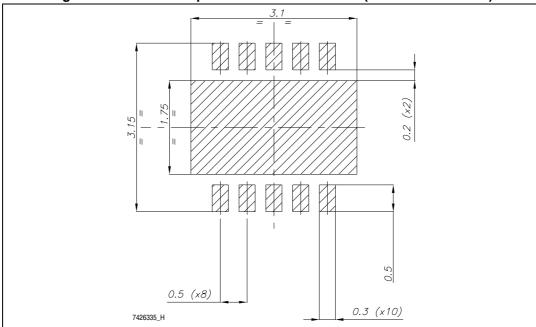


Figure 16. DFN10L footprint - recommended data (dimensions in mm.)

Revision history STEF05D

8 Revision history

Table 8. Document revision history

Date	Revision	Changes
19-Mar-2013	1	Initial release.

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

ST PRODUCTS ARE NOT AUTHORIZED FOR USE IN WEAPONS. NOR ARE ST PRODUCTS DESIGNED OR AUTHORIZED FOR USE IN: (A) SAFETY CRITICAL APPLICATIONS SUCH AS LIFE SUPPORTING, ACTIVE IMPLANTED DEVICES OR SYSTEMS WITH PRODUCT FUNCTIONAL SAFETY REQUIREMENTS; (B) AERONAUTIC APPLICATIONS; (C) AUTOMOTIVE APPLICATIONS OR ENVIRONMENTS, AND/OR (D) AEROSPACE APPLICATIONS OR ENVIRONMENTS. WHERE ST PRODUCTS ARE NOT DESIGNED FOR SUCH USE, THE PURCHASER SHALL USE PRODUCTS AT PURCHASER'S SOLE RISK, EVEN IF ST HAS BEEN INFORMED IN WRITING OF SUCH USAGE, UNLESS A PRODUCT IS EXPRESSLY DESIGNATED BY ST AS BEING INTENDED FOR "AUTOMOTIVE, AUTOMOTIVE SAFETY OR MEDICAL" INDUSTRY DOMAINS ACCORDING TO ST PRODUCT DESIGN SPECIFICATIONS. PRODUCTS FORMALLY ESCC, QML OR JAN QUALIFIED ARE DEEMED SUITABLE FOR USE IN AEROSPACE BY THE CORRESPONDING GOVERNMENTAL AGENCY.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2013 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

